

### **TISP4070M3LM THRU TISP4115M3LM, TISP4125M3LM THRU TISP4220M3LM, TISP4240M3LM THRU TISP4400M3LM**

### **BIDIRECTIONAL THYRISTOR OVERVOLTAGE PROTECTORS**

## **TISP4xxxM3LM Overvoltage Protector Series**

#### **TISP4xxxM3LM Overview**

This TISP<sup>®</sup> device series protects central office, access and customer premise equipment against overvoltages on the telecom line. The TISP4xxxM3LM is available in a wide range of voltages and has a medium current capability. These protectors have been specified mindful of the following standards and recommendations: GR-1089-CORE, FCC Part 68, UL1950, EN 60950, IEC 60950, ITU-T K.20, K.21 and K.45. The TISP4350M3LM meets the FCC Part 68 "B" ringer voltage requirement and survives the Type B impulse tests. These devices are housed in a through-hole DO-92 package (TO-92 package with cropped center leg).

### **Summary Electrical Characteristics**



B ourns' part has an improved protection voltage

### **Summary Current Ratings**



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 **LM Package (Top View)**

**ITU-T K.20/21 Rating ...........................4 kV 10/700,100 A 5/310**

#### **Ion-Implanted Breakdown Region Precise and Stable Voltage Low Voltage Overshoot under Surge**



### **Rated for International Surge Wave Shapes**



### $T(A)$ 1 NC  $\blacksquare$ 2 3  $R(B)$ MD4XAT NC - No internal connection on pin 2 **LMF Package (LM Package with Formed Leads) (Top View)**  $T(A)$   $\subset$ 1 NC 2 3  $R(B)$   $\subset$ MD4XAKB NC - No internal connection on pin 2 **Device Symbol T R** SD4XAA Terminals T and R correspond to the alternative line designators of A and B **Low Differential Capacitance .................................. 43 pF max. .. UL Recognized Component** W

### **Description**

These devices are designed to limit overvoltages on the telephone line. Overvoltages are normally caused by a.c. power system or lightning flash disturbances which are induced or conducted on to the telephone line. A single device provides 2-point protection and is typically used for the protection of 2-wire telecommunication equipment (e.g. between the Ring and Tip wires for telephones and modems). Combinations of devices can be used for multi-point protection (e.g. 3-point protection between Ring, Tip and Ground).

### **How To Order**



Insert xxx value corresponding to protection voltages of 070, 080, 095, 115 etc.

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Customers should verify actual device performance in their specific applications.

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### **Description (continued)**

The protector consists of a symmetrical voltage-triggered bidirectional thyristor. Overvoltages are initially clipped by breakdown clamping until the voltage rises to the breakover level, which causes the device to crowbar into a low-voltage on state. This low-voltage on state causes the current resulting from the overvoltage to be safely diverted through the device. The high crowbar holding current prevents d.c. latchup as the diverted current subsides.

This TISP4xxxM3LM range consists of seventeen voltage variants to meet various maximum system voltage levels (58 V to 320 V). They are guaranteed to voltage limit and withstand the listed international lightning surges in both polarities. These protection devices are supplied in a DO-92 (LM) cylindrical plastic package. The TISP4xxxM3LM is a straight lead DO-92 supplied in bulk pack and on tape and reel. The TISP4xxxM3LMF is a formed lead DO-92 supplied only on tape and reel. For higher rated impulse currents in the DO-92 package, the 100 A 10/1000 TISP4xxxH3LM series is available.

### Absolute Maximum Ratings, T<sub>A</sub> = 25 °C (Unless Otherwise Noted)



NOTES: 1. See Applications Information and Figure 10 for voltage values at lower temperatures.

2. Initially the TISP4xxxM3LM must be in thermal equilibrium with  $T_{\text{J}} = 25 \text{ }^{\circ}\text{C}$ .

- 3. The surge may be repeated after the TISP4xxxM3LM returns to its initial conditions.
- 4. See Applications Information and Figure 11 for current ratings at other temperatures.
- 5. EIA/JESD51-2 environment and EIA/JESD51-3 PCB with standard footprint dimensions connected with 5 A rated printed wiring track widths. See Figure 8 for the current ratings at other durations. Derate current values at -0.61 %/°C for ambient temperatures above 25 °C

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### **Electrical Characteristics, T<sub>A</sub> = 25 °C (Unless Otherwise Noted)**

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### Electrical Characteristics,  $T_A = 25$  °C (Unless Otherwise Noted) (continued)



NOTE 6: To avoid possible voltage clipping, the '4125 is tested with  $V_D$  = -98 V.

### **Thermal Characteristics**



NOTE 7: EIA/JESD51-2 environment and PCB has standard footprint dimensions connected with 5 A rated printed wiring track widths.

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### **Parameter Measurement Information**



**Figure 1. Voltage-current Characteristic for T and R Terminals All Measurements are Referenced to the R Terminal**

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TC4MAD

### **Typical Characteristics**



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### **Typical Characteristics**





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#### **Rating and Thermal Information**











### **APPLICATIONS INFORMATION**

#### **Deployment**

These devices are two terminal overvoltage protectors. They may be used either singly to limit the voltage between two conductors (Figure 12) or in multiples to limit the voltage at several points in a circuit (Figure 13).







In Figure 12, protector Th1 limits the maximum voltage between the two conductors to  $\pm V_{(BO)}$ . This configuration is normally used to protect circuits without a ground reference, such as modems. In Figure 13, protectors Th2 and Th3 limit the maximum voltage between each conductor and ground to the  $\pm V_{(BO)}$  of the individual protector. Protector Th1 limits the maximum voltage between the two conductors to its  $\pm V_{(BO)}$ value. If the equipment being protected has all its vulnerable components connected between the conductors and ground, then protector Th1 is not required.

### **Impulse Testing**

To verify the withstand capability and safety of the equipment, standards require that the equipment is tested with various impulse wave forms. The table below shows some common values.



† FCC Part 68 terminology for the waveforms produced by the ITU-T recommendation K.21 10/700 impulse generator

If the impulse generator current exceeds the protector's current rating, then a series resistance can be used to reduce the current to the protector's rated value to prevent possible failure. The required value of series resistance for a given waveform is given by the following calculations. First, the minimum total circuit impedance is found by dividing the impulse generator's peak voltage by the protector's rated current. The impulse generator's fictive impedance (generator's peak voltage divided by peak short circuit current) is then subtracted from the minimum total circuit impedance to give the required value of series resistance.

For the FCC Part 68 10/560 waveform the following values result. The minimum total circuit impedance is 800/75 = 10.7  $\Omega$  and the generator's fictive impedance is 800/100 = 8  $\Omega$ . This gives a minimum series resistance value of 10.7 - 8 = 2.7  $\Omega$ . After allowing for tolerance, a 3  $\Omega \pm 10\%$ resistor would be suitable. The 10/160 waveform needs a standard resistor value of 5.6  $\Omega$  per conductor. These would be R1a and R1b in Figure 15 and Figure 16. FCC Part 68 allows the equipment to be non-operational after the 10/160 (conductor to ground) and 10/560 (interconductor) impulses. The series resistor value may be reduced to zero to pass FCC Part 68 in a non-operational mode, e.g. Figure 14. For this type of design, the series fuse must open before the TISP4xxxM3 fails. For Figure 14, the maximum fuse i<sup>2</sup>t is 2.3 A<sup>2</sup>s. In some cases, the equipment will require verification over a temperature range. By using the rated waveform values from Figure 11, the appropriate series resistor value can be calculated for ambient temperatures in the range of -40 °C to 85 °C.

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### **APPLICATIONS INFORMATION**

### **AC Power Testing**

The protector can withstand currents applied for times not exceeding those shown in Figure 8. Currents that exceed these times must be terminated or reduced to avoid protector failure. Fuses, PTC (Positive Temperature Coefficient) resistors and fusible resistors are overcurrent protection devices which can be used to reduce the current flow. Protective fuses may range from a few hundred milliamperes to one ampere. In some cases, it may be necessary to add some extra series resistance to prevent the fuse from opening during impulse testing. The current versus time characteristic of the overcurrent protector must be below the line shown in Figure 8. In some cases there may be a further time limit imposed by the test standard (e.g. UL 1459 wiring simulator failure).

#### **Capacitance**

The protector characteristic off-state capacitance values are given for d.c. bias voltage, V<sub>D</sub>, values of 0, -1 V, -2 V and -50 V. Where possible, values are also given for -100 V. Values for other voltages may be calculated by multiplying the  $V_D = 0$  capacitance value by the factor given in Figure 6. Up to 10 MHz, the capacitance is essentially independent of frequency. Above 10 MHz, the effective capacitance is strongly dependent on connection inductance. In many applications, such as Figure 15 and Figure 17, the typical conductor bias voltages will be about -2 V and -50 V. Figure 7 shows the differential (line unbalance) capacitance caused by biasing one protector at -2 V and the other at -50 V.

#### **Normal System Voltage Levels**

The protector should not clip or limit the voltages that occur in normal system operation. For unusual conditions, such as ringing without the line connected, some degree of clipping is permissible. Under this condition, about 10 V of clipping is normally possible without activating the ring trip circuit.

Figure 10 allows the calculation of the protector  $V_{DRM}$  value at temperatures below 25 °C. The calculated value should not be less than the maximum normal system voltages. The TISP4260M3LM, with a V<sub>DRM</sub> of 200 V, can be used for the protection of ring generators producing 100 V rms of ring on a battery voltage of -58 V (Th2 and Th3 in Figure 17). The peak ring voltage will be 58 + 1.414\*100 = 199.4 V. However, this is the open circuit voltage and the connection of the line and its equipment will reduce the peak voltage. In the extreme case of an unconnected line, clipping the peak voltage to 190 V should not activate the ring trip. This level of clipping would occur at the temperature when the V<sub>DRM</sub> has reduced to 190/200 = 0.95 of its 25 °C value. Figure 10 shows that this condition will occur at an ambient temperature of -28 °C. In this example, the TISP4260M3LM will allow normal equipment operation provided that the minimum expected ambient temperature does not fall below -28 °C.

#### **JESD51 Thermal Measurement Method**

To standardize thermal measurements, the EIA (Electronic Industries Alliance) has created the JESD51 standard. Part 2 of the standard (JESD51-2, 1995) describes the test environment. This is a 0.0283 m<sup>3</sup> (1 ft<sup>3</sup>) cube which contains the test PCB (Printed Circuit Board) horizontally mounted at the center. Part 3 of the standard (JESD51-3, 1996) defines two test PCBs for surface mount components; one for packages smaller than 27 mm (1.06 ") on a side and the other for packages up to 48 mm (1.89 "). The LM package measurements used the smaller 76.2 mm x 114.3 mm (3.0 " x 4.5 ") PCB. The JESD51-3 PCBs are designed to have low effective thermal conductivity (high thermal resistance) and represent a worse case condition. The PCBs used in the majority of applications will achieve lower values of thermal resistance and so can dissipate higher power levels than indicated by the JESD51 values.

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**Typical Circuits**





**Figure 16. ISDN Protection**

AI6XBL

**D.C.**



**Figure 17. Line Card Ring/Test Protection**

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### **MECHANICAL DATA**

### **Device Symbolization Code**

Devices will be coded as below.



### **Carrier Information**

Devices are shipped in one of the carriers below. A reel contains 2000 devices.





### **MECHANICAL DATA**

### **LM002 (DO-92) 2-Pin Cylindrical Plastic Package**

#### **2-Pin Cylindrical Plastic Package**

This single-in-line package consists of a circuit mounted on a lead frame and encapsulated within a plastic compound. The compound will withstand soldering temperature with no deformation, and circuit performance characteristics will remain stable when operated in high humidity conditions. Leads require no additional cleaning or processing when used in soldered assembly.



MD4XARA

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### **MECHANICAL DATA**

### **LM002 (DO-92) - Formed Leads Version- 2-Pin Cylindrical Plastic Package**

This single-in-line package consists of a circuit mounted on a lead frame and encapsulated within a plastic compound. The compound will withstand soldering temperature with no deformation, and circuit performance characteristics will remain stable when operated in high humidity conditions. Leads require no additional cleaning or processing when used in soldered assembly.



MD4XASA

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### **MECHANICAL DATA**

**Tape Dimensions**



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